

Electronic Acknowledgement Receipt

EFS ID:	1218476
Application Number:	09471460
Confirmation Number:	7429
Title of Invention:	USE OF A PLASMA SOURCE TO FORM A LAYER DURING THE FORMATION OF A SEMICONDUCTOR DEVICE
First Named Inventor:	Thomas A Figura
Customer Number:	21186
Filer:	Daniel J. Mertes/Kathleen Gannon
Filer Authorized By:	Daniel J. Mertes
Attorney Docket Number:	94-0280.03
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Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		303932US4.pdf	631433	yes	12

Multipart Description			
Doc Desc		Start	End
Transmittal letter		1	1
Miscellaneous Incoming Letter		2	2
Amendment After Final		3	3
Claims		4	6
Applicant Arguments/Remarks Made in an Amendment		7	12

Warnings:

Information:

Total Files Size (in bytes):	631433
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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.